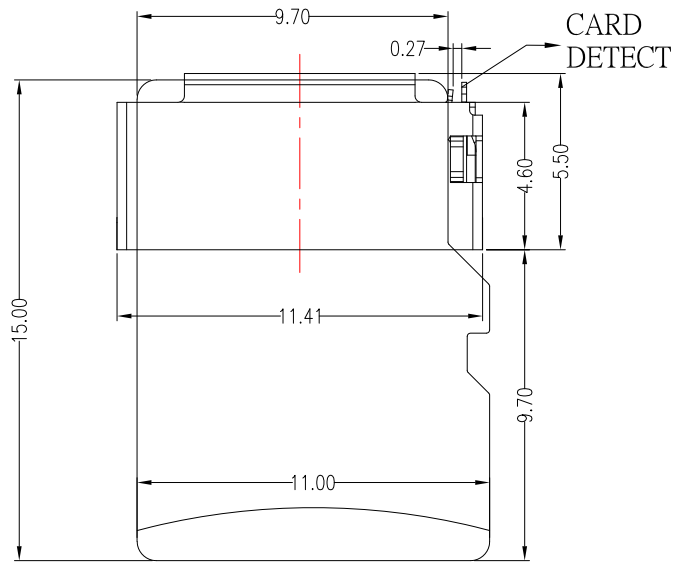
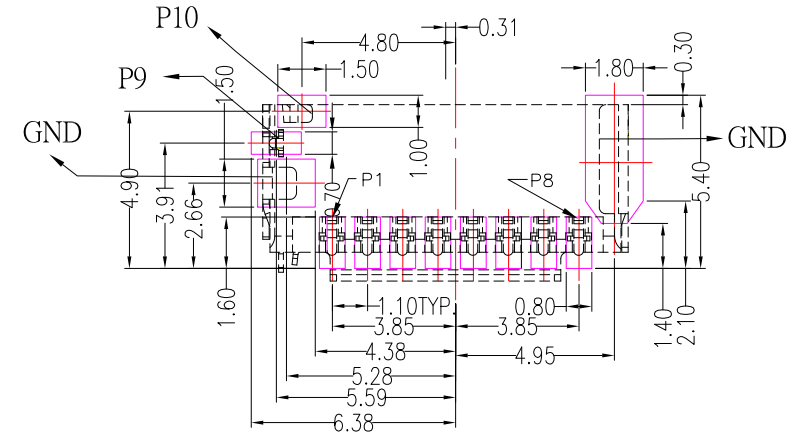


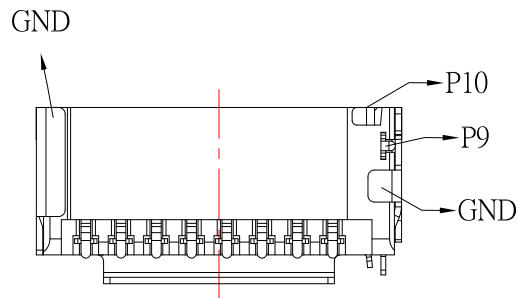
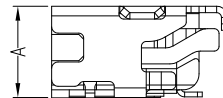
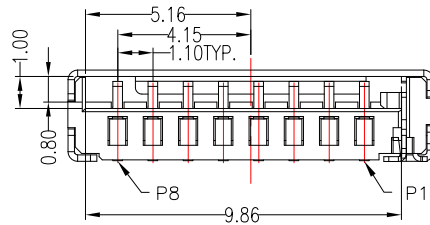


SD-TF03-1108x-S267

	DIM A
5	3.00
6	3.35
7	3.75



PCB LAYOYT



SPECIFICATION

Electrical :

- 1.Current Rating: 0.5A
- 2.Contact Resistance: 50 mΩ Max.
- 3.Insulation Resistance: 1000 MΩ Min.
- 4.Dirlectric Withstanding: 500V AC

Mechanical:

- 1.Life Cyeles: 1500 cycles Min
- 2.Mate Force: 4.5kgf Max
- 3.Unmate Force: 0.5kgf Min

Environmental:

- 1.Operating Temperature: -25°C ~ +85°C.

Material:

- 1.Housing: LCP
- 2.Contact: Phosphor Bronze
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

Pin No.	NAME
P1	DAT2
P2	CD/DAT3
P3	CMD
P4	VDD
P5	CLK
P6	VSS
P7	DAT0
P8	DAT1
P9	CARD DETECT
P10	CARD DETECT

9	新舊PIN標示	Jack	042425
8	更新圖面	Jack	052924
7	更新高度選項	Jack	102517
6	更新高度選項	Jack	011617
5	新增尺寸	Jack	011217
ITEM NO.	DESCRIPTION	DRAWN	DATE

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°
3RD. ANGEL'S
UNITS
MM

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR
Jack Lu	04/24/25	FINISH		MODEL	MICRO SD 卡 短體帶偵測PIN
CHECKED BY:	DATE	SCALE	1 : 1	DWG NO.	SD-TF03-1108x-S267
Jacky Chen	04/24/25	SHEET NO.	1 of 1	PART NO.	SD-TF03-1108x-S267
APPROVED BY:	DATE				
Tony Kao	04/24/25				